SHD625061 SHD625061D SHD625061N SHD625061P

TECHNICAL DATA DATA SHEET 4141, REV. -

HERMETIC SILICON CARBIDE RECTIFIER

DESCRIPTION/FEATURES:

600V, 40A, POWER SILICON CARBIDE RECTIFIER AVAILABLE SCREENED TO ANY REQUIRED LEVEL

- NO RECOVERY TIME OR REVERSE RECOVERY LOSSES
- NO TEMPERATURE INFLUENCE ON SWITCHING BEHAVIOR
- High Temperature Option Maximum operation & storage temperature can be increased to 250°C; use part number prefix SHDT
- High Frequency Option Non-magnetic Glidcop leads are available for improved performance at high frequency; use part number prefix SHDG
- Ceramic Seal Option For ceramic seals use part number prefix SHDC

MAXIMUM RATINGS

ALL RATINGS ARE @ T_C = 25 °C UNLESS OTHERWISE SPECIFIED.

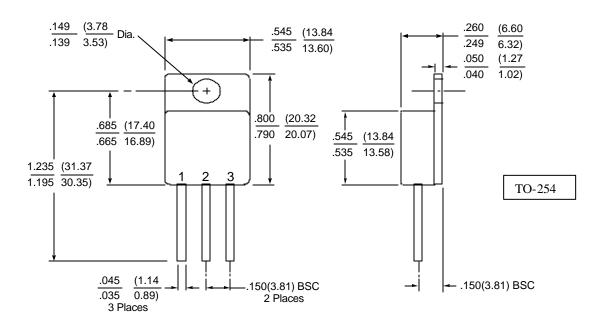
RATING	SYMBOL	MAX.	UNIT S
PEAK INVERSE VOLTAGE	PIV	600	Volts
MAXIMUM DC OUTPUT CURRENT (With T_C = 65 $^{\rm O}$ C, for part numbers with P and N suffixes)	lo	40	Amps
MAXIMUM DC OUTPUT CURRENT (With T_C = 65 $^{\rm O}$ C, for part numbers with Single and D suffixes)	lo	20	Amps
MAXIMUM REPETITIVE FORWARD SURGE CURRENT PER LEG (t = 8.3ms, Sine) per leg, $T_{\rm C}$ = 25 $^{\rm O}{\rm C}$	I _{FRM}	80	Amps
MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT PER LEG (t = 10 μ s, Pulse) per leg, T _C = 25 $^{\circ}$ C	I _{FSM}	250	Amps
MAXIMUM JUNCTION CAPACITANCE (V _r =5V) per leg	Ст	450	pF
MAXIMUM POWER DISSIPATION, $T_C = 25$ $^{\circ}C$	P _d	80	W
MAXIMUM THERMAL RESISTANCE, Junction to Case (PER DUAL PACKAGE For Common Cathode/Anode Configurations)	R _θ JC	1.1	°C/W
MAXIMUM OPERATING AND STORAGE TEMPERATURE RANGE	Top, Tstg	-55 to +175	°C

ELECTRICAL CHARACTERISTICS

CHARACTERISTIC		TYP	MAX.	UNIT S
MAXIMUM FORWARD VOLTAGE DROP, Pulsed	T _J = 25 °C	1.35	1.45	
(I _f = 12 A PER LEG) V _f	$T_J = 150$ °C	1.50	1.60	Volts
MAXIMUM FORWARD VOLTAGE DROP, Pulsed	T _J = 25 °C	1.65	1.80	
(I _f = 20 A PER LEG) V _f	T _J = 150 °C	1.85	2.00	Volts
MAXIMUM REVERSE CURRENT (Ir @ 600V PIV PER	R LEG) T _J = 25 °C	0.08	0.30	mΑ
	T _J = 150 °C	0.15	1.00	
TOTAL CAPACITIVE CHARGE	Q _C per leg	50	N/A	nC
(V _R =600V I _F =20A di/dt=500A/ μ s T _J =25°C)				

TECHNICAL DATA DATA SHEET 4141, REV. -

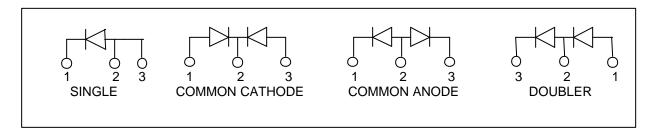
MECHANICAL DIMENSIONS



PINOUT TABLE

TYPE	PIN 1	PIN 2	PIN 3
SINGLE RECTIFIER	CATHODE	ANODE	ANODE
DUAL RECTIFIER/COMMON CATHODE (P)	ANODE 1	COMMON	ANODE 2
		CATHODE	
DUAL RECTIFIER/COMMON ANODE (N)	CATHODE 1	COMMON	CATHODE 2
		ANODE	
DUAL RECTIFIER/DOUBLER (D)	ANODE	ANODE/	CATHODE
		CATHODE	

SCHEMATIC



Application Note: Customers should be aware that at the current stage of technical development of SiC, the reverse avalanche capabilities of the device are limited.

Customer designs will need to accommodate these limitations and avoid exposure of the device to this and other potentially damaging conditions in their applications.



TECHNICAL DATA

DISCLAIMER:

- 1- The information given herein, including the specifications and dimensions, is subject to change without prior notice to improve product characteristics. Before ordering, purchasers are advised to contact the Sensitron Semiconductor sales department for the latest version of the datasheet(s).
- 2- In cases where extremely high reliability is required (such as use in nuclear power control, aerospace and aviation, traffic equipment, medical equipment, and safety equipment), safety should be ensured by using semiconductor devices that feature assured safety or by means of users' fail-safe precautions or other arrangement.
- 3- In no event shall Sensitron Semiconductor be liable for any damages that may result from an accident or any other cause during operation of the user's units according to the datasheet(s). Sensitron Semiconductor assumes no responsibility for any intellectual property claims or any other problems that may result from applications of information, products or circuits described in the datasheets.
- 4- In no event shall Sensitron Semiconductor be liable for any failure in a semiconductor device or any secondary damage resulting from use at a value exceeding the absolute maximum rating.
- 5- No license is granted by the datasheet(s) under any patents or other rights of any third party or Sensitron Semiconductor.
- 6- The datasheet(s) may not be reproduced or duplicated, in any form, in whole or part, without the expressed written permission of Sensitron Semiconductor.
- 7- The products (technologies) described in the datasheet(s) are not to be provided to any party whose purpose in their application will hinder maintenance of international peace and safety nor are they to be applied to that purpose by their direct purchasers or any third party. When exporting these products (technologies), the necessary procedures are to be taken in accordance with related laws and regulations.